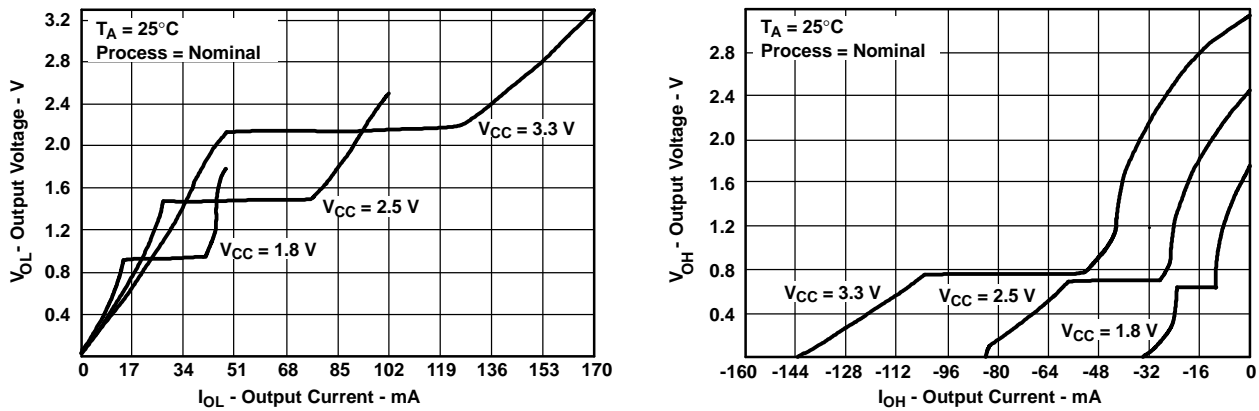


**FEATURES**

- Member of the Texas Instruments Widebus™ Family
- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- DOC™ (Dynamic Output Control) Circuit Dynamically Changes Output Impedance, Resulting in Noise Reduction Without Speed Degradation
- Dynamic Drive Capability Is Equivalent to Standard Outputs With  $I_{OH}$  and  $I_{OL}$  of  $\pm 24$  mA at 2.5-V  $V_{CC}$
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- Package Options Include Plastic Thin Shrink Small-Outline (DGG) and Thin Very Small-Outline (DGV) Packages

**DESCRIPTION**

A Dynamic Output Control (DOC™) circuit is implemented, which, during the transition, initially lowers the output impedance to effectively drive the load and, subsequently, raises the impedance to reduce noise. Figure 1 shows typical  $V_{OL}$  vs  $I_{OL}$  and  $V_{OH}$  vs  $I_{OH}$  curves to illustrate the output impedance and drive capability of the circuit. At the beginning of the signal transition, the DOC circuit provides a maximum dynamic drive that is equivalent to a high-drive standard-output device. For more information, refer to the TI application reports, *AVC Logic Family Technology and Applications*, literature number SCEA006, and *Dynamic Output Control (DOC™) Circuitry Technology and Applications*, literature number SCEA009.



**Figure 1. Output Voltage vs Output Current**

This 16-bit transparent D-type latch is operational at 1.2-V to 3.6-V  $V_{CC}$ , but is designed specifically for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74AVC16373 is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers. This device can be used as two 8-bit latches or one 16-bit latch. When the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the levels set up at the D inputs.

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components.  $\overline{OE}$  does not affect internal operations of the latch. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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**SN74AVC16373**  
**16-BIT TRANSPARENT D-TYPE LATCH**  
**WITH 3-STATE OUTPUTS**

SCES156G–DECEMBER 1998–REVISED MAY 2005

**DESCRIPTION (CONTINUED)**

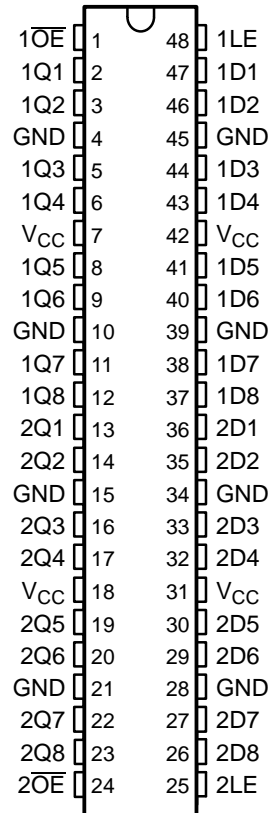
To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The SN74AVC16373 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

**TERMINAL ASSIGNMENTS**

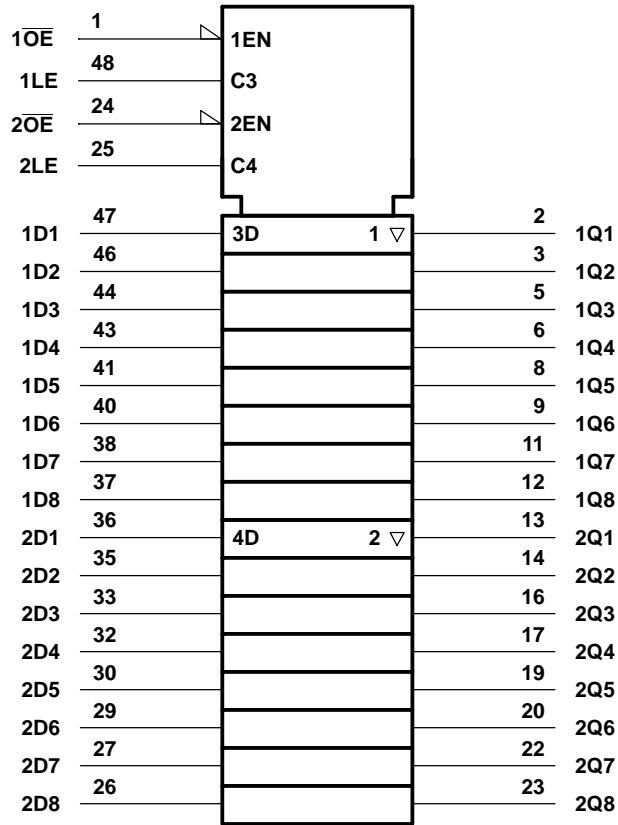
**DGG OR DGV PACKAGE**  
**(TOP VIEW)**



**FUNCTION TABLE  
(EACH 8-BIT LATCH)**

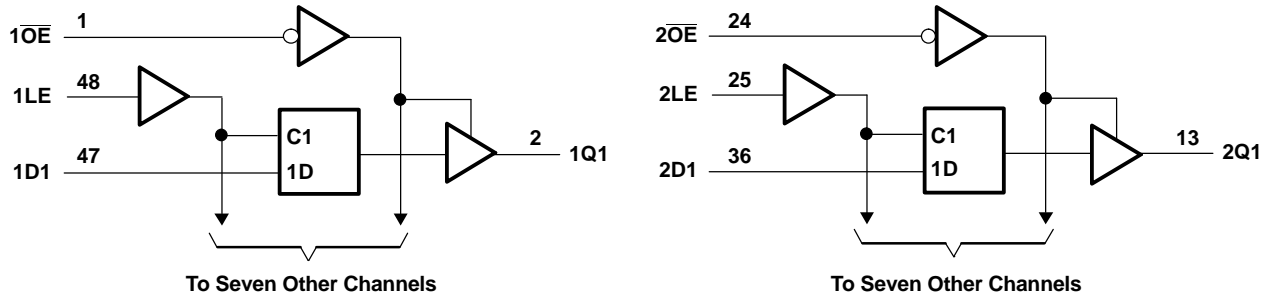
| INPUTS          |    |   | OUTPUT<br>Q |
|-----------------|----|---|-------------|
| $\overline{OE}$ | LE | D |             |
| L               | H  | H | H           |
| L               | H  | L | L           |
| L               | L  | X | $Q_0$       |
| H               | X  | X | Z           |

**LOGIC SYMBOL<sup>(1)</sup>**



(1) This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

**LOGIC DIAGRAM (POSITIVE LOGIC)**



**SN74AVC16373**  
**16-BIT TRANSPARENT D-TYPE LATCH**  
**WITH 3-STATE OUTPUTS**

SCES156G–DECEMBER 1998–REVISED MAY 2005

**Absolute Maximum Ratings<sup>(1)</sup>**

over operating free-air temperature range (unless otherwise noted)

|               |   | MIN         | MAX            | UNIT |
|---------------|---|-------------|----------------|------|
| $V_{CC}$      | Supply voltage range  | -0.5        | 4.6            | V    |
| $V_I$         | Input voltage range <sup>(2)</sup>  | -0.5        | 4.6            | V    |
| $V_O$         | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> | -0.5        | 4.6            | V    |
| $V_O$         | Voltage range applied to any output in the high or low state <sup>(2)(3)</sup>              | -0.5        | $V_{CC} + 0.5$ | V    |
| $I_{IK}$      | Input clamp current   | $V_I < 0$   | -50            | mA   |
| $I_{OK}$      | Output clamp current  | $V_O < 0$   | -50            | mA   |
| $I_O$         | Continuous output current   |             | ±50            | mA   |
|               | Continuous current through each $V_{CC}$ or GND   |             | ±100           | mA   |
| $\theta_{JA}$ | Package thermal impedance <sup>(4)</sup>  | DGG package | 70             | °C/W |
|               |   | DGV package | 58             |      |
| $T_{stg}$     | Storage temperature range   | -65         | 150            | °C   |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.
- (4) The package thermal impedance is calculated in accordance with JESD 51.

**Recommended Operating Conditions<sup>(1)</sup>**

|                  |   | MIN                                | MAX                    | UNIT            |      |
|------------------|---|------------------------------------|------------------------|-----------------|------|
| V <sub>CC</sub>  | Supply voltage                                  | Operating                          | 1.4                    | 3.6             | V    |
|                  |   | Data retention only                | 1.2                    |                 |      |
| V <sub>IH</sub>  | High-level input voltage                        | V <sub>CC</sub> = 1.2 V            | V <sub>CC</sub>        |                 | V    |
|                  |   | V <sub>CC</sub> = 1.4 V to 1.6 V   | 0.65 × V <sub>CC</sub> |                 |      |
|                  |   | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.65 × V <sub>CC</sub> |                 |      |
|                  |   | V <sub>CC</sub> = 2.3 V to 2.7 V   | 1.7                    |                 |      |
|                  |   | V <sub>CC</sub> = 3 V to 3.6 V     | 2                      |                 |      |
| V <sub>IL</sub>  | Low-level input voltage                         | V <sub>CC</sub> = 1.2 V            | GND                    |                 | V    |
|                  |   | V <sub>CC</sub> = 1.4 V to 1.6 V   | 0.35 × V <sub>CC</sub> |                 |      |
|                  |   | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.35 × V <sub>CC</sub> |                 |      |
|                  |   | V <sub>CC</sub> = 2.3 V to 2.7 V   | 0.7                    |                 |      |
|                  |   | V <sub>CC</sub> = 3 V to 3.6 V     | 0.8                    |                 |      |
| V <sub>I</sub>   | Input voltage                                   | 0                                  | 3.6                    | V               |      |
| V <sub>O</sub>   | Output voltage                                  | Active state                       | 0                      | V <sub>CC</sub> | V    |
|                  |   | 3-state                            | 0                      | 3.6             |      |
| I <sub>OHS</sub> | Static high-level output current <sup>(2)</sup> | V <sub>CC</sub> = 1.4 V to 1.6 V   | –2                     |                 | mA   |
|                  |   | V <sub>CC</sub> = 1.65 V to 1.95 V | –4                     |                 |      |
|                  |   | V <sub>CC</sub> = 2.3 V to 2.7 V   | –8                     |                 |      |
|                  |   | V <sub>CC</sub> = 3 V to 3.6 V     | –12                    |                 |      |
| I <sub>OLS</sub> | Static low-level output current <sup>(2)</sup>  | V <sub>CC</sub> = 1.4 V to 1.6 V   | 2                      |                 | mA   |
|                  |   | V <sub>CC</sub> = 1.65 V to 1.95 V | 4                      |                 |      |
|                  |   | V <sub>CC</sub> = 2.3 V to 2.7 V   | 8                      |                 |      |
|                  |   | V <sub>CC</sub> = 3 V to 3.6 V     | 12                     |                 |      |
| Δt/Δv            | Input transition rise or fall rate              | V <sub>CC</sub> = 1.4 V to 3.6 V   |                        | 5               | ns/V |
| T <sub>A</sub>   | Operating free-air temperature                  | –40                                | 85                     | °C              |      |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

(2) Dynamic drive capability is equivalent to standard outputs with I<sub>OH</sub> and I<sub>OL</sub> of ±24 mA at 2.5-V V<sub>CC</sub>. See Figure 1 for V<sub>OL</sub> vs I<sub>OL</sub> and V<sub>OH</sub> vs I<sub>OH</sub> characteristics. Refer to the TI application reports, *AVC Logic Family Technology and Applications*, literature number SCEA066, and *Dynamic Output Control (DOC™) Circuitry Technology and Applications*, literature number SCEA009.

# SN74AVC16373

## 16-BIT TRANSPARENT D-TYPE LATCH

### WITH 3-STATE OUTPUTS

SCES156G–DECEMBER 1998–REVISED MAY 2005

### Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        |                | TEST CONDITIONS   | V <sub>CC</sub> | MIN                   | TYP <sup>(1)</sup> | MAX  | UNIT |
|------------------|----------------|---|-----------------|-----------------------|--------------------|------|------|
| V <sub>OH</sub>  |                | I <sub>OHS</sub> = -100 μA                                  | 1.4 V to 3.6 V  | V <sub>CC</sub> - 0.2 |                    |      | V    |
|                  |                | I <sub>OHS</sub> = -2 mA, V <sub>IH</sub> = 0.91 V          | 1.4 V           | 1.05                  |                    |      |      |
|                  |                | I <sub>OHS</sub> = -4 mA, V <sub>IH</sub> = 1.07 V          | 1.65 V          | 1.2                   |                    |      |      |
|                  |                | I <sub>OHS</sub> = -8 mA, V <sub>IH</sub> = 1.7 V           | 2.3 V           | 1.75                  |                    |      |      |
|                  |                | I <sub>OHS</sub> = -12 mA, V <sub>IH</sub> = 2 V            | 3 V             | 2.3                   |                    |      |      |
| V <sub>OL</sub>  |                | I <sub>OLS</sub> = 100 μA                                   | 1.4 V to 3.6 V  |                       |                    | 0.2  | V    |
|                  |                | I <sub>OLS</sub> = 2 mA, V <sub>IL</sub> = 0.49 V           | 1.4 V           |                       |                    | 0.4  |      |
|                  |                | I <sub>OLS</sub> = 4 mA, V <sub>IL</sub> = 0.57 V           | 1.65 V          |                       |                    | 0.45 |      |
|                  |                | I <sub>OLS</sub> = 8 mA, V <sub>IL</sub> = 0.7 V            | 2.3 V           |                       |                    | 0.55 |      |
|                  |                | I <sub>OLS</sub> = 12 mA, V <sub>IL</sub> = 0.8 V           | 3 V             |                       |                    | 0.7  |      |
| I <sub>I</sub>   |                | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 3.6 V           |                       |                    | ±2.5 | μA   |
| I <sub>off</sub> |                | V <sub>I</sub> or V <sub>O</sub> = 3.6 V                    | 0               |                       |                    | ±10  | μA   |
| I <sub>OZ</sub>  |                | V <sub>O</sub> = V <sub>CC</sub> or GND                     | 3.6 V           |                       |                    | ±10  | μA   |
| I <sub>CC</sub>  |                | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 | 3.6 V           |                       |                    | 40   | μA   |
| C <sub>i</sub>   | Control inputs | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 2.5 V           | 3                     |                    | pF   |      |
|                  |                |   | 3.3 V           | 3                     |                    |      |      |
|                  | Data inputs    | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 2.5 V           | 2.5                   |                    |      |      |
|                  |                |   | 3.3 V           | 2.5                   |                    |      |      |
| C <sub>O</sub>   | Outputs        | V <sub>O</sub> = V <sub>CC</sub> or GND                     | 2.5 V           | 6.5                   |                    | pF   |      |
|                  |                |   | 3.3 V           | 6.5                   |                    |      |      |

(1) Typical values are measured at V<sub>CC</sub> = 2.5 V and 3.3 V, T<sub>A</sub> = 25°C.

### Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see [Figure 2](#) through [Figure 5](#))

|                 |                             | V <sub>CC</sub> = 1.2 V |     | V <sub>CC</sub> = 1.5 V ± 0.1 V |     | V <sub>CC</sub> = 1.8 V ± 0.15 V |     | V <sub>CC</sub> = 2.5 V ± 0.2 V |     | V <sub>CC</sub> = 3.3 V ± 0.3 V |     | UNIT |
|-----------------|-----------------------------|-------------------------|-----|---------------------------------|-----|----------------------------------|-----|---------------------------------|-----|---------------------------------|-----|------|
|                 |                             | MIN                     | MAX | MIN                             | MAX | MIN                              | MAX | MIN                             | MAX | MIN                             | MAX |      |
| t <sub>w</sub>  | Pulse duration, LE high     |                         |     |                                 |     | 2.2                              |     | 2                               |     | 1.8                             |     | ns   |
| t <sub>su</sub> | Setup time, data before LE↓ | 1.7                     |     | 1.2                             |     | 1.1                              |     | 0.9                             |     | 0.8                             |     | ns   |
| t <sub>h</sub>  | Hold time, data after LE↓   | 2                       |     | 1.1                             |     | 1.1                              |     | 1.1                             |     | 1                               |     | ns   |

### Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see [Figure 2](#) through [Figure 5](#))

| PARAMETER        | FROM (INPUT)    | TO (OUTPUT) | V <sub>CC</sub> = 1.2 V |  | V <sub>CC</sub> = 1.5 V ± 0.1 V |     | V <sub>CC</sub> = 1.8 V ± 0.15 V |     | V <sub>CC</sub> = 2.5 V ± 0.2 V |     | V <sub>CC</sub> = 3.3 V ± 0.3 V |     | UNIT |
|------------------|-----------------|-------------|-------------------------|--|---------------------------------|-----|----------------------------------|-----|---------------------------------|-----|---------------------------------|-----|------|
|                  |                 |             | TYP                     |  | MIN                             | MAX | MIN                              | MAX | MIN                             | MAX | MIN                             | MAX |      |
| t <sub>pd</sub>  | D               | Q           | 5.8                     |  | 1.2                             | 6.8 | 1                                | 5.7 | 0.8                             | 3.3 | 0.7                             | 2.8 | ns   |
|                  | LE              |             | 7.2                     |  | 1.4                             | 8.3 | 1.1                              | 6.6 | 0.8                             | 4   | 0.7                             | 3.2 |      |
| t <sub>en</sub>  | $\overline{OE}$ | Q           | 7.4                     |  | 1.6                             | 8.8 | 1.6                              | 6.7 | 1.4                             | 4.3 | 0.7                             | 3.4 | ns   |
| t <sub>dis</sub> | $\overline{OE}$ | Q           | 8.4                     |  | 2.5                             | 9.4 | 2.3                              | 7.8 | 1.3                             | 4.2 | 1.2                             | 3.9 | ns   |

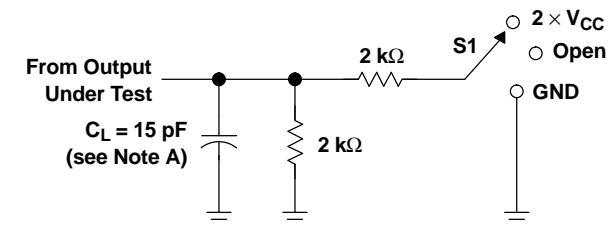
**Operating Characteristics**

$T_A = 25^\circ\text{C}$

| PARAMETER |                               | TEST CONDITIONS  | $V_{CC} = 1.8\text{ V}$ | $V_{CC} = 2.5\text{ V}$ | $V_{CC} = 3.3\text{ V}$ | UNIT |
|-----------|-------------------------------|------------------|-------------------------|-------------------------|-------------------------|------|
|           |                               |                  | TYP                     | TYP                     | TYP                     |      |
| $C_{pd}$  | Power dissipation capacitance | Outputs enabled  | 40                      | 43                      | 47                      | pF   |
|           |                               | Outputs disabled | 20                      | 22                      | 24                      |      |

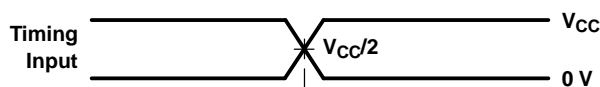
**PARAMETER MEASUREMENT INFORMATION**

$V_{CC} = 1.2\text{ V AND }1.5\text{ V} \pm 0.1\text{ V}$

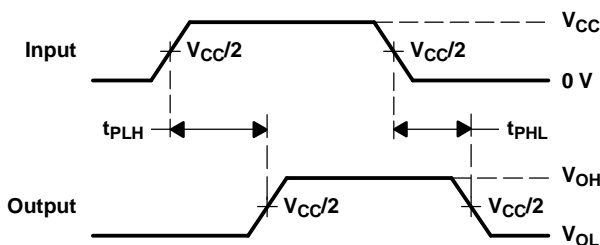


**LOAD CIRCUIT**

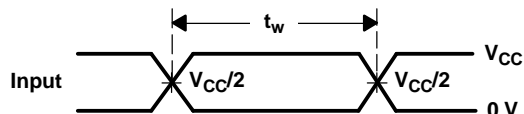
| TEST              | S1                |
|-------------------|-------------------|
| $t_{pd}$          | Open              |
| $t_{PLZ}/t_{PZL}$ | $2 \times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND               |



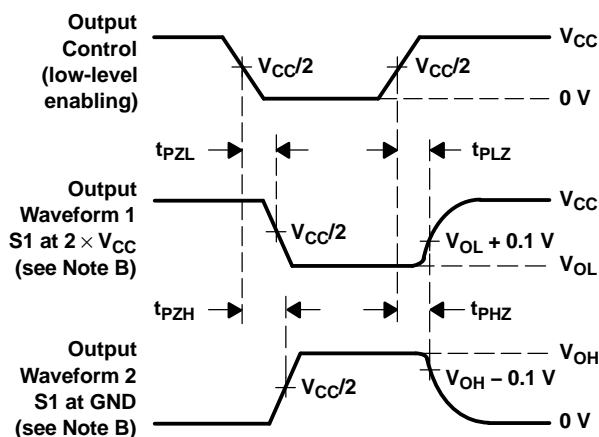
**VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES**



**VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES**



**VOLTAGE WAVEFORMS  
PULSE DURATION**



**VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES**

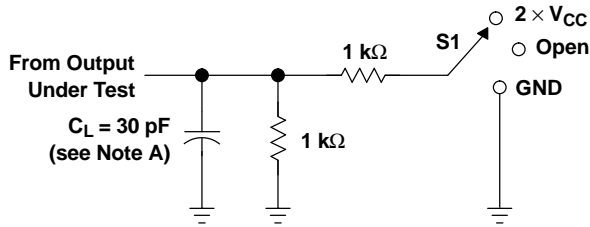
- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .  
D. The outputs are measured one at a time, with one transition per measurement.  
E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

**Figure 2. Load Circuit and Voltage Waveforms**



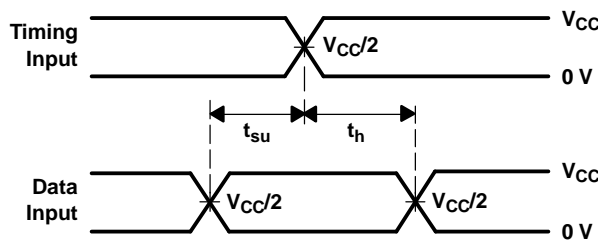
PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 1.8\text{ V} \pm 0.15\text{ V}$

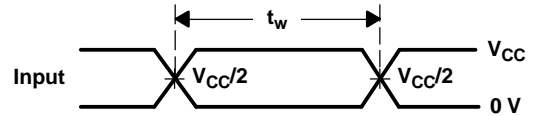


LOAD CIRCUIT

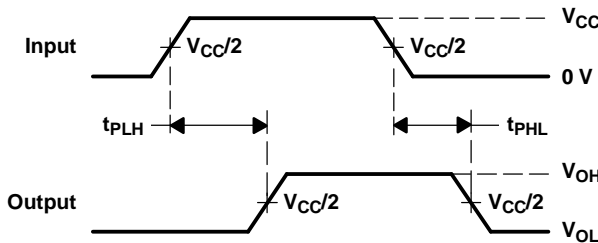
| TEST              | S1                  |
|-------------------|---------------------|
| $t_{pd}$          | Open                |
| $t_{PLZ}/t_{PZL}$ | 2 $\times$ $V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND                 |



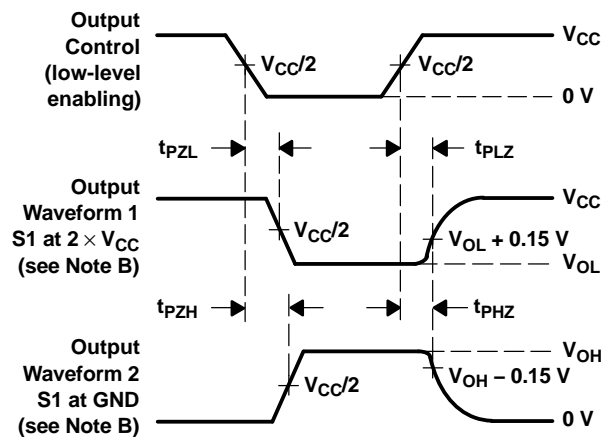
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



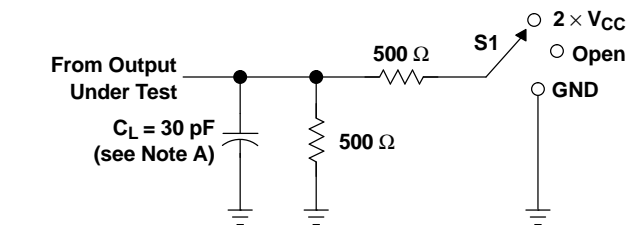
VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .  
 D. The outputs are measured one at a time, with one transition per measurement.  
 E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
 G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 3. Load Circuit and Voltage Waveforms

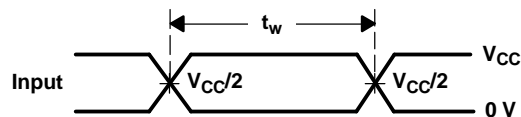
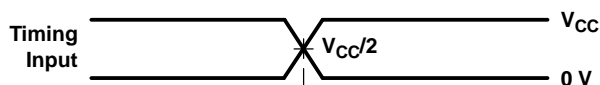
**PARAMETER MEASUREMENT INFORMATION**

$V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$

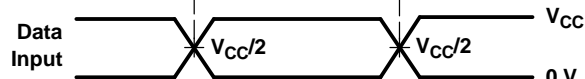


**LOAD CIRCUIT**

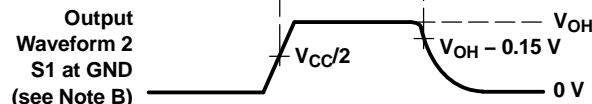
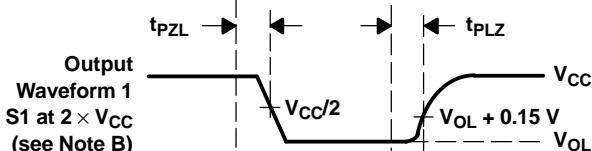
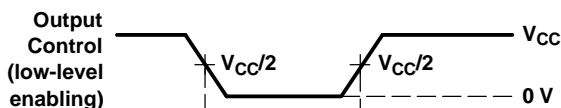
| TEST              | S1                  |
|-------------------|---------------------|
| $t_{pd}$          | Open                |
| $t_{PLZ}/t_{PZL}$ | 2 $\times$ $V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND                 |



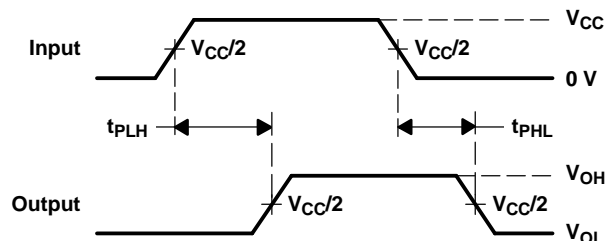
**VOLTAGE WAVEFORMS**  
**PULSE DURATION**



**VOLTAGE WAVEFORMS**  
**SETUP AND HOLD TIMES**



**VOLTAGE WAVEFORMS**  
**ENABLE AND DISABLE TIMES**

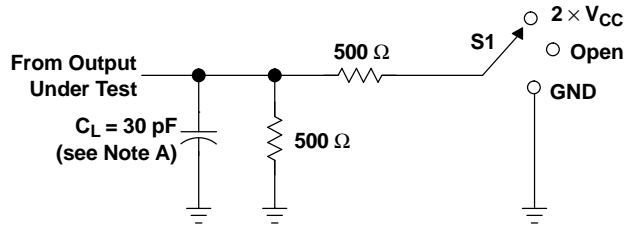


**VOLTAGE WAVEFORMS**  
**PROPAGATION DELAY TIMES**

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .  
D. The outputs are measured one at a time, with one transition per measurement.  
E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

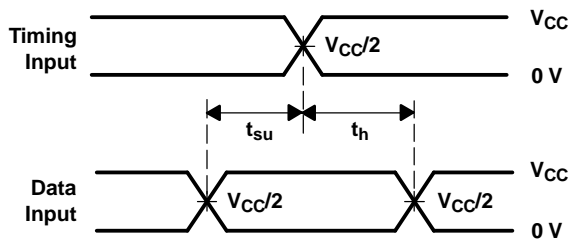
**Figure 4. Load Circuit and Voltage Waveforms**

PARAMETER MEASUREMENT INFORMATION  
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$

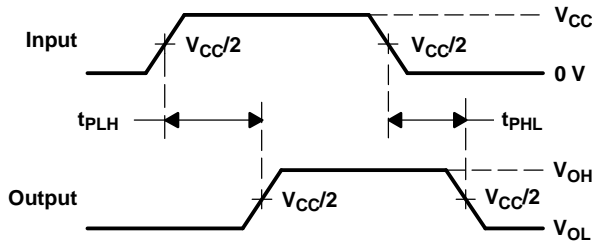


LOAD CIRCUIT

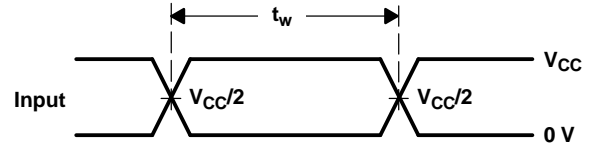
| TEST              | S1                  |
|-------------------|---------------------|
| $t_{pd}$          | Open                |
| $t_{PLZ}/t_{PZL}$ | 2 $\times$ $V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND                 |



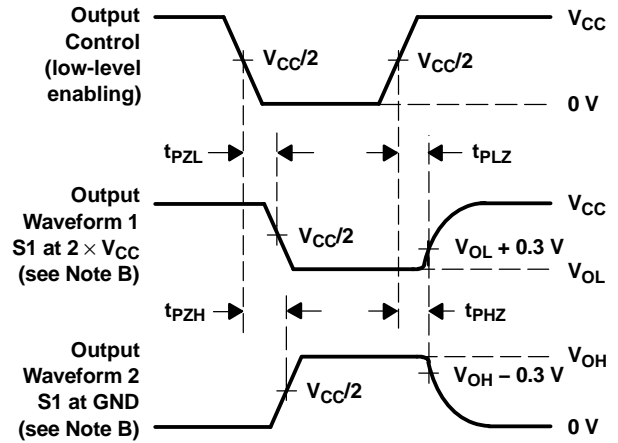
VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2\text{ ns}$ ,  $t_f \leq 2\text{ ns}$ .  
 D. The outputs are measured one at a time, with one transition per measurement.  
 E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
 G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 5. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type                     | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|----------------------------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 74AVC16373DGGRG4 | ACTIVE                | TSSOP                            | DGG             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74AVC16373DGVRE4 | ACTIVE                | TVSOP                            | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74AVC16373DGVRG4 | ACTIVE                | TVSOP                            | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AVC16373DGGR | ACTIVE                | TSSOP                            | DGG             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AVC16373DGVR | ACTIVE                | TVSOP                            | DGV             | 48   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AVC16373GQLR | NRND                  | BGA MI<br>CROSTA<br>R JUNI<br>OR | GQL             | 56   | 1000        | TBD                     | SNPB             | Level-1-240C-UNLIM           |
| SN74AVC16373ZQLR | ACTIVE                | BGA MI<br>CROSTA<br>R JUNI<br>OR | ZQL             | 56   | 1000        | Green (RoHS & no Sb/Br) | SNAGCU           | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**



**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



\*All dimensions are nominal

| Device           | Package Type         | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|----------------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AVC16373DGGR | TSSOP                | DGG             | 48   | 2000 | 330.0              | 24.4               | 8.6     | 15.8    | 1.8     | 12.0    | 24.0   | Q1            |
| SN74AVC16373DGVR | TVSOP                | DGV             | 48   | 2000 | 330.0              | 24.4               | 6.8     | 10.1    | 1.6     | 12.0    | 24.0   | Q1            |
| SN74AVC16373GQLR | BGA MICROSTAR JUNIOR | GQL             | 56   | 1000 | 330.0              | 16.4               | 4.8     | 7.3     | 1.45    | 8.0     | 16.0   | Q1            |
| SN74AVC16373ZQLR | BGA MICROSTAR JUNIOR | ZQL             | 56   | 1000 | 330.0              | 16.4               | 4.8     | 7.3     | 1.45    | 8.0     | 16.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**

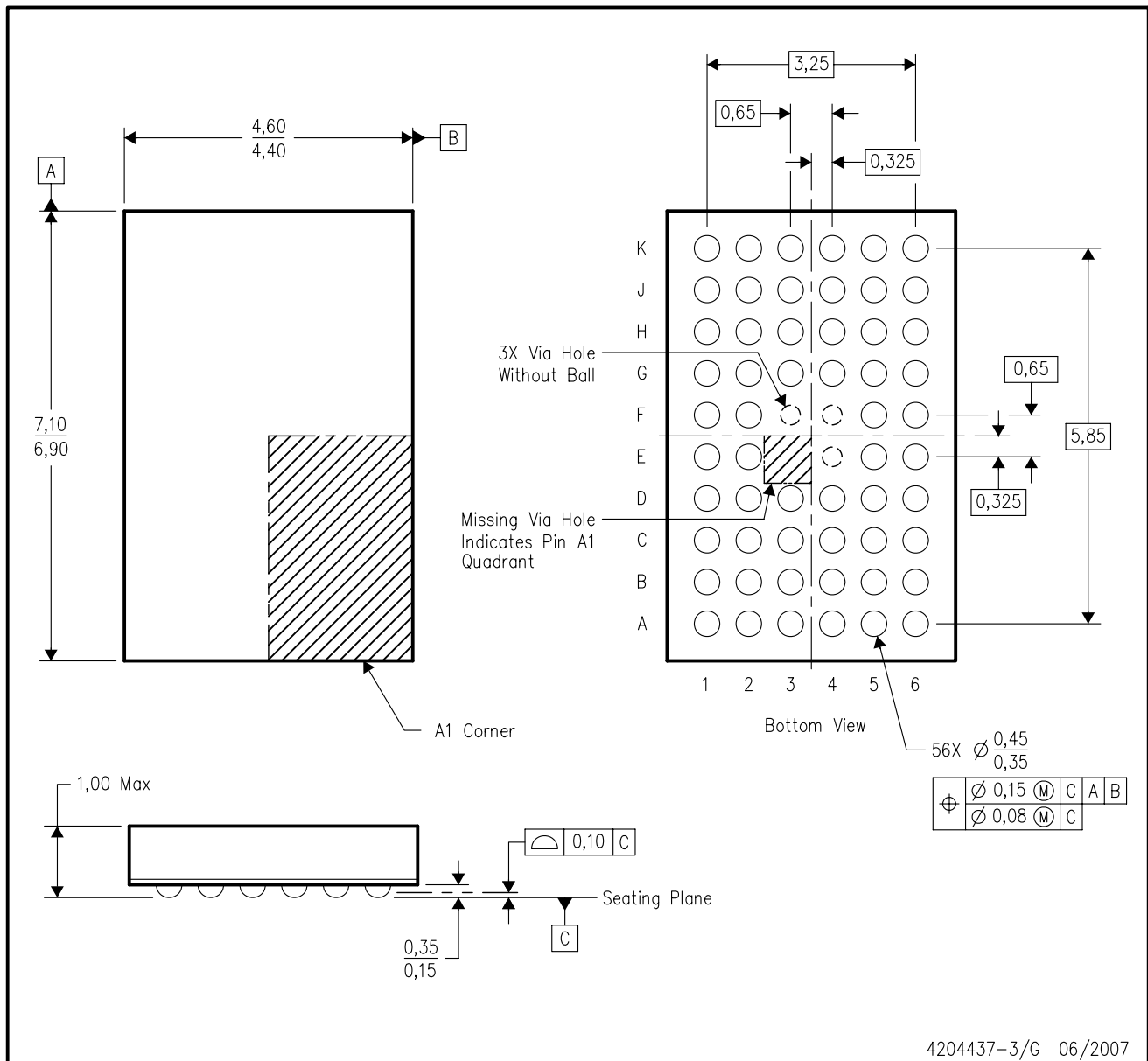


\*All dimensions are nominal

| Device           | Package Type         | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|----------------------|-----------------|------|------|-------------|------------|-------------|
| SN74AVC16373DGGR | TSSOP                | DGG             | 48   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74AVC16373DGVR | TVSOP                | DGV             | 48   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74AVC16373GQLR | BGA MICROSTAR JUNIOR | GQL             | 56   | 1000 | 346.0       | 346.0      | 33.0        |
| SN74AVC16373ZQLR | BGA MICROSTAR JUNIOR | ZQL             | 56   | 1000 | 346.0       | 346.0      | 33.0        |

ZQL (R-PBGA-N56)

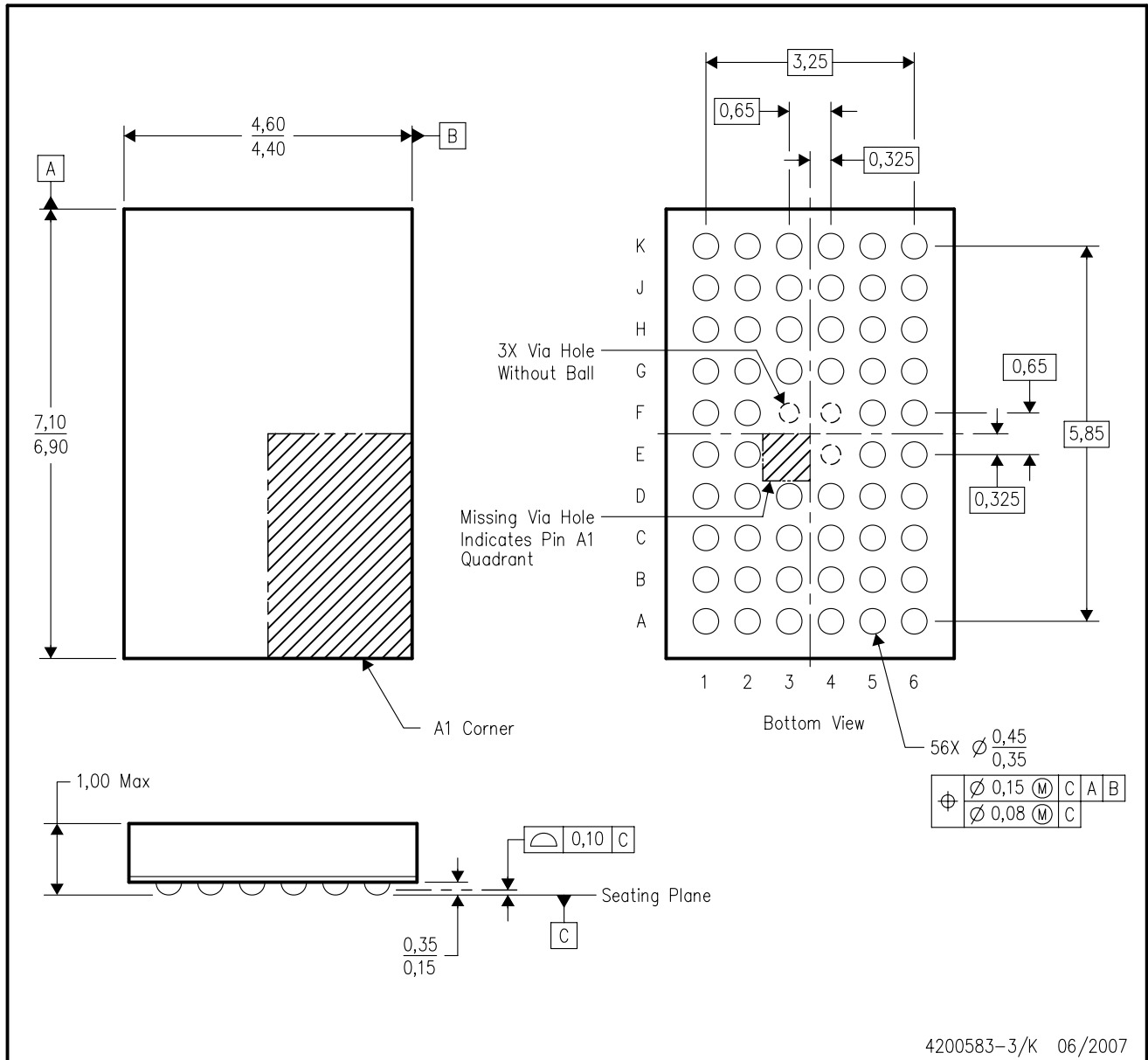
PLASTIC BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MO-285 variation BA-2.
  - D. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).

GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MO-285 variation BA-2.
  - D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.



DGG (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

DGV (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

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